

### N-Channel Super Junction Power MOSFET III

#### **General Description**

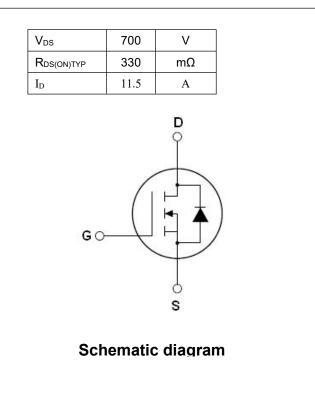
The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

#### Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

#### Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)



#### Package Marking And Ordering Information

Device	Device Package	Marking
NCE70T360K	TO-252	NCE70T360K
NCE70T360I	TO-251	NCE70T360I

### Table 1. Absolute Maximum Ratings ( $T_c=25^{\circ}$ C)

Parameter	Symbol	Value	Unit	
Drain-Source Voltage (VGs=0V)	VDS	700	V	
Gate-Source Voltage (VDS=0V) AC (f>1 Hz)	Vgs	±30	V	
Continuous Drain Current at T <sub>c</sub> =25°C	I <sub>D (DC)</sub>	11.5	A	
Continuous Drain Current at T <sub>C</sub> =100°C	I <sub>D (DC)</sub>	7	A	
Pulsed drain current <sup>(Note 1)</sup>	DM (pluse)	46	A	
Maximum Power Dissipation(T_c =25 $^{\circ}$ C)	PD	101	W	
Derate above 25°C		0.97	W/°C	
Single pulse avalanche energy <sup>(Note2)</sup>	Eas	144	mJ	
Avalanche current <sup>(Note 1)</sup>	I <sub>AR</sub>	6	A	
Repetitive Avalanche energy ${,}t_{AR}$ limited by $T_{jmax}$ (Note 1)	E <sub>AR</sub>	0.5	mJ	

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## NCE70T360K,NCE70T360I

Parameter	Symbol	Value	Unit	
Drain Source voltage slope, $V_{DS} \leqslant 480 V$ ,	dv/dt	50	V/ns	
Reverse diode dv/dt, $V_{DS} \leqslant 480 \text{ V}, I_{SD} < I_D$	dv/dt	15	V/ns	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55+150	°C	

#### Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	1.24	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	62	°C /W

#### Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit		
On/off states	On/off states							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	700			V		
Zero Gate Voltage Drain Current(Tc=25°C)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V		0.05	1	μA		
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =700V,V <sub>GS</sub> =0V			100	μA		
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V			±100	nA		
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	3	3.5	4	V		
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	$V_{GS}$ =10V, $I_{D}$ =7A		330	390	mΩ		
Dynamic Characteristics								
Input Capacitance	C <sub>iss</sub>			870		pF		
Output Capacitance	Coss	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V, F=1.0MHz		54		pF		
Reverse Transfer Capacitance	Crss			1.8		pF		
Total Gate Charge	Qg			19		nC		
Gate-Source Charge	Qgs	V <sub>DS</sub> =480V,I <sub>D</sub> =11.5A, V <sub>GS</sub> =10V		6		nC		
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> -10V		6.5		nC		
Switching times								
Turn-on Delay Time	t <sub>d(on)</sub>			12		nS		
Turn-on Rise Time	tr	V <sub>DD</sub> =420V,I <sub>D</sub> =5.5A,		9		nS		
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G=3\Omega, V_{GS}=10V$		61	70	nS		
Turn-Off Fall Time	t <sub>f</sub>			11	14	nS		
Source- Drain Diode Characteristics								
Source-drain current(Body Diode)	I <sub>SD</sub>	T 05%0			11.5	A		
Pulsed Source-drain current(Body Diode)	I <sub>SDM</sub>	Tc=25°C			46	А		
Forward on voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =11.5A,V <sub>GS</sub> =0V		0.9	1.2	V		
Reverse Recovery Time	t <sub>rr</sub>	Tj=25°C,I <sub>F</sub> =5.8A,		220		nS		
Reverse Recovery Charge	Qrr			2.2		uC		
Peak Reverse Recovery Current	Irrm	di/dt=100A/µs		19		А		

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R<sub>G</sub>=25 $\Omega$ 



### **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)**

#### Figure1. Safe operating area

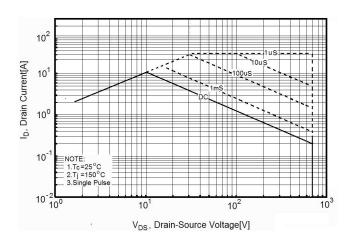


Figure3. Source-Drain Diode Forward Voltage

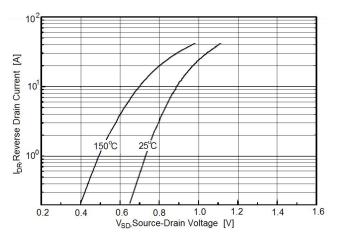
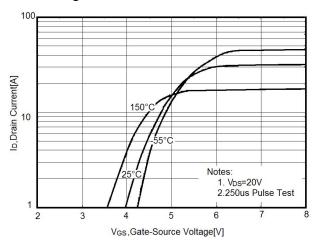
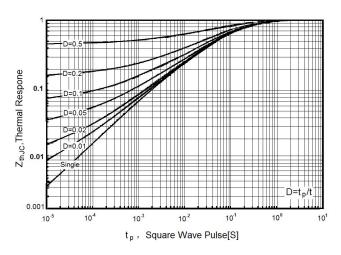


Figure5. Transfer characteristics



#### Figure2. Transient Thermal Impedance



#### Figure4. Output characteristics

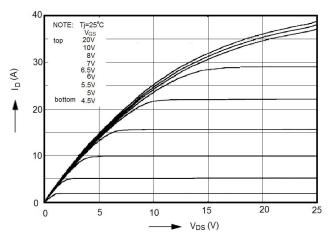


Figure6. Static drain-source on resistance

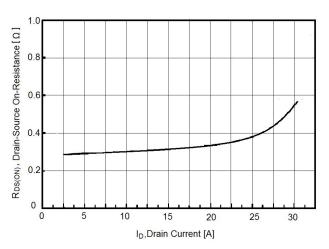




Figure7. R<sub>DS(ON)</sub> vs Junction Temperature

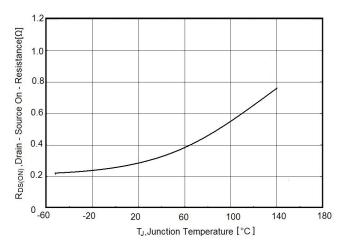


Figure9. Maximum I<sub>D</sub> vs Junction Temperature

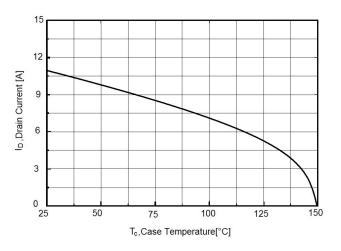


Figure8. BV<sub>DSS</sub> vs Junction Temperature

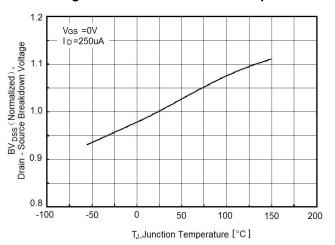
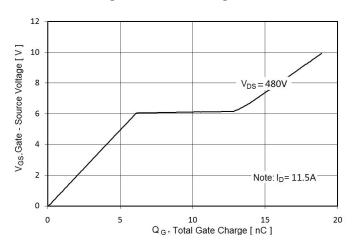
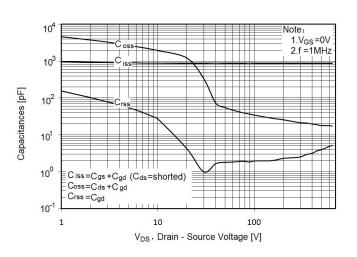


Figure10. Gate charge waveforms



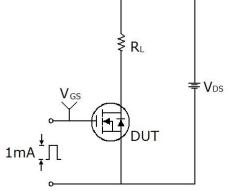


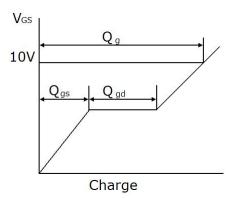




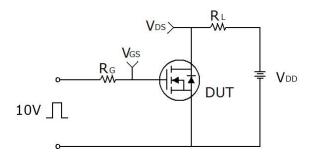
### Test circuit

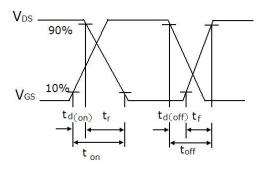
1) Gate charge test circuit & Waveform



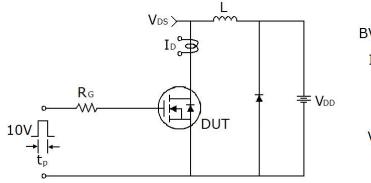


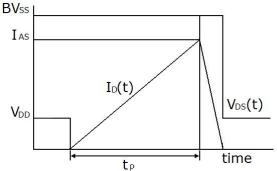
2) Switch Time Test Circuit:





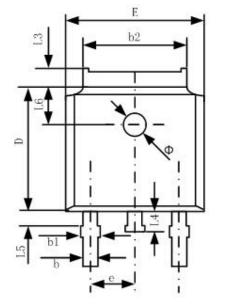
3) Unclamped Inductive Switching Test Circuit & Waveforms

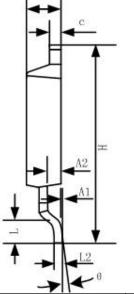


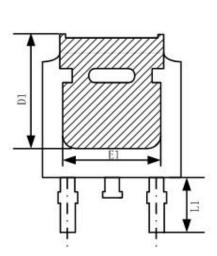




## **TO-252-2 Package Information**





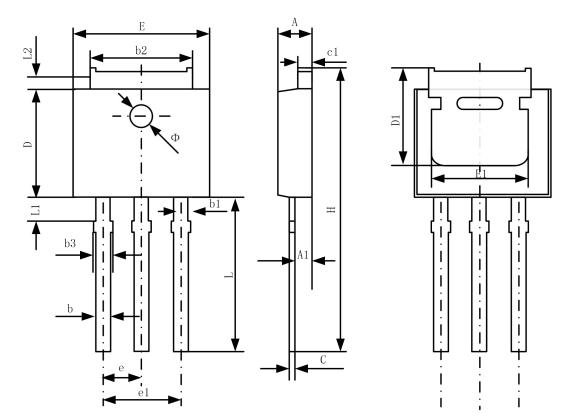


Cumhal	Dimensions	s In Millimeters	Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
А	2.20	2.38	0.087	0.094
A1	0.00	0.10	0.000	0.004
A2	0.90	1.10	0.035	0.043
b	0.72	0.85	0.028	0.033
b1	0.72	0.90	0.028	0.035
b2	5.13	5.46	0.202	0.215
С	0.47	0.60	0.019	0.024
D	6.00	6.20	0.236	0.244
D1	5.25		0.207	
E	6.50	6.70	0.256	0.264
E1	4.70		0.185	
e	2.19	2.39	0.086	0.094
Н	9.80	10.40	0.386	0.409
L	1.40	1.70	0.055	0.067
L1	2.90 REF		0.114	REF
L2	0.508 BSC		0.020	) BSC
L3	0.90	1.25	0.035	0.049
L4	0.60	1.00	0.024	0.039
L5	0.15	0.75	0.006	0.030
L6	1.8	0 REF	0.071	I REF
Φ	1.20	1.40	0.047	0.055
θ	0°	8°	0°	8°

# **TO-251 Package Information**

# NCE70T360K,NCE70T360I





Ourseland I	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
E	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	

### ATTENTION:

# NCE70T360K,NCE70T360I



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